

STGW75M65DF2, STGWA75M65DF2

Trench gate field-stop IGBT, M series 650 V, 75 A low-loss in TO-247 and TO-247 long leads packages

Datasheet - production data

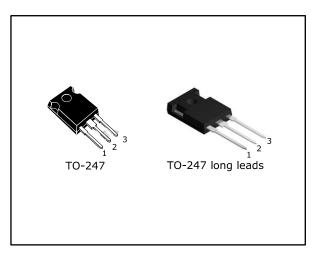
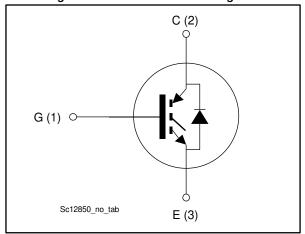


Figure 1: Internal schematic diagram



Features

- 6 μs of short-circuit withstand time
- $V_{CE(sat)} = 1.65 \text{ V (typ.)} @ I_C = 75 \text{ A}$
- Tight parameter distribution
- Safer paralleling
- Positive V_{CE(sat)} temperature coefficient
- Low thermal resistance
- Soft and very fast recovery antiparallel diode
- Maximum junction temperature: T_J = 175 °C

Applications

- Motor control
- UPS
- PFC
- General purpose inverter

Description

These devices are IGBTs developed using an advanced proprietary trench gate field-stop structure. The devices are part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive $V_{\text{CE(sat)}}$ temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

Order code	Marking	Package	Packing
STGW75M65DF2	OZEMCEDEO	TO-247	Tuba
STGWA75M65DF2	G75M65DF2	TO-247 long leads	Tube

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vces	Collector-emitter voltage (V _{GE} = 0 V)	650	V
lc ⁽¹⁾	Continuous collector current at T _C = 25 °C	120	Α
lc	Continuous collector current at T _C = 100 °C	75	Α
ICP ⁽²⁾	Pulsed collector current	225	Α
V_{GE}	Gate-emitter voltage	±20	V
I _F ⁽¹⁾	Continuous forward current at T _C = 25 °C	120	Α
l _F	Continuous forward current at T _C = 100 °C	75	Α
I _{FP} ⁽²⁾	Pulsed forward current	225	Α
Ртот	Total dissipation at T _C = 25 °C	468	W
Tstg	Storage temperature range - 55 to 150		°C
T_J	Operating junction temperature range	- 55 to 175	°C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{th} JC	Thermal resistance junction-case IGBT	0.32	°C/W
R _{thJC}	Thermal resistance junction-case diode	0.74	°C/W
R _{thJA}	Thermal resistance junction-ambient	50	°C/W

⁽¹⁾Current level is limited by bond wires

 $[\]ensuremath{^{(2)}}\mbox{Pulse}$ width limited by maximum junction temperature.

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2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 4: Static characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$	650			V
		$V_{GE} = 15 \text{ V}, I_{C} = 75 \text{ A}$		1.65	2.1	
V _{CE(sat)}	V _{CE(sat)} Collector-emitter saturation	V _{GE} = 15 V, I _C = 75 A, T _J = 125 °C		1.95		V
voltage	V _{GE} = 15 V, I _C = 75 A, T _J = 175 °C		2.1			
		I _F = 75 A		2	2.85	
V_{F}	Forward on-voltage	I _F =75 A, T _J = 125 °C		1.75		V
		I _F = 75 A, T _J = 175 °C		1.6		
$V_{\text{GE(th)}}$	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 2 \text{ mA}$	5	6	7	V
I _{CES}	Collector cut-off current	$V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}$			25	μΑ
I _{GES}	Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = \pm 20 \text{ V}$			±250	μΑ

Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		-	6290	1	
Coes	Output capacitance	$V_{CE} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GE} = 0 \text{ V}$	-	390	1	pF
Cres	Reverse transfer capacitance	Val - 0 V	-	136	ı	
Qg	Total gate charge	$V_{CC} = 520 \text{ V}, I_C = 75 \text{ A},$	-	225	1	
Q_{ge}	Gate-emitter charge	V _{GE} = 0 to 15 V (see <i>Figure 30: " Gate</i>	-	53	1	nC
Qgc	Gate-collector charge	charge test circuit")	-	87	-	

Table 6: IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time			47	-	ns
tr	Current rise time			22.4	-	ns
(di/dt) _{on}	Turn-on current slope	V _{CE} = 400 V, I _C = 75 A,		2680	-	A/μs
t _{d(off)}	Turn-off-delay time	$V_{GE} = 15 \text{ V}, R_G = 3.3 \Omega$		125	-	ns
t _f	Current fall time	(see Figure 29: " Test circuit for inductive load		93	-	ns
E _{on} (1)	Turn-on switching energy	switching")		0.69	-	mJ
E _{off} (2)	Turn-off switching energy			2.54	-	mJ
Ets	Total switching energy			3.23	-	mJ
t _{d(on)}	Turn-on delay time			48	-	ns
tr	Current rise time			25	-	ns
(di/dt) _{on}	Turn-on current slope	$V_{CE} = 400 \text{ V}, I_{C} = 75 \text{ A},$ $V_{GE} = 15 \text{ V}, R_{G} = 3.3 \Omega$		2420	-	A/μs
t _{d(off)}	Turn-off-delay time	T _J = 175 °C		125	-	ns
tf	Current fall time	(see Figure 29: " Test		167	-	ns
E _{on} (1)	Turn-on switching energy	circuit for inductive load switching")		2.17	-	mJ
E _{off} (2)	Turn-off switching energy	, containing ,		3.45	-	mJ
E _{ts}	Total switching energy			5.62	-	mJ
	Chart aircuit withstand time	V _{CC} ≤ 400 V, V _{GE} = 13 V, T _{Jstart} ≤ 150 °C	10		-	
lsc	t _{sc} Short-circuit withstand time	V _{CC} ≤ 400 V, V _{GE} = 15 V, T _{Jstart} ≤ 150 °C	6			μs

Notes:

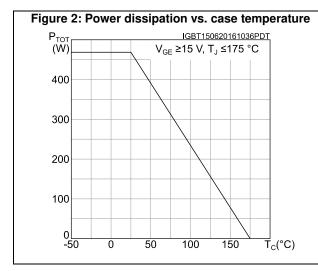
Table 7: Diode switching characteristics (inductive load)

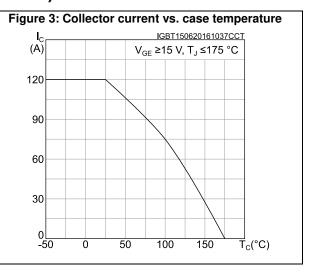
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
trr	Reverse recovery time	75 4 1/ 400 1/	ı	165	1	ns
Qrr	Reverse recovery charge	I _F = 75 A, V _R = 400 V, V _{GE} = 15 V,	ı	1.72	ı	μC
Irrm	Reverse recovery current	di/dt = 1000 A/µs	ı	25	-	Α
dl _{rr} /dt	Peak rate of fall of reverse recovery current during t _b	(see Figure 29: " Test circuit for inductive load switching")	ı	750	ı	A/μs
Err	Reverse recovery energy	Switching)	ı	289	1	μJ
t _{rr}	Reverse recovery time	I _F = 75 A, V _R = 400 V,	ı	256	ı	ns
Qrr	Reverse recovery charge	V _{GE} = 15 V,	ı	6.85	1	μC
I _{rrm}	Reverse recovery current	di/dt = 1000 A/µs, Tɹ = 175 °C	1	48	ı	Α
dl _{rr} /dt	Peak rate of fall of reverse recovery current during tb	(see Figure 29: " Test circuit for inductive load	ı	300	ı	A/μs
Err	Reverse recovery energy	switching")	-	1033	-	μJ

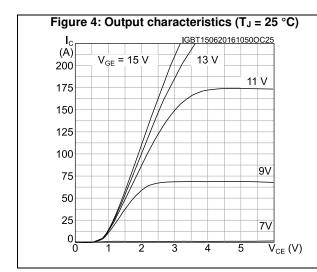
⁽¹⁾Including the reverse recovery of the diode.

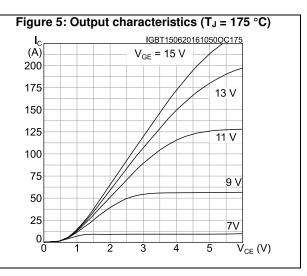
 $[\]ensuremath{^{(2)}}\mbox{Including}$ the tail of the collector current.

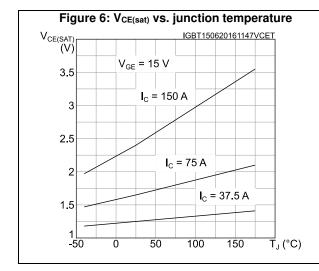
2.1 Electrical characteristics (curves)

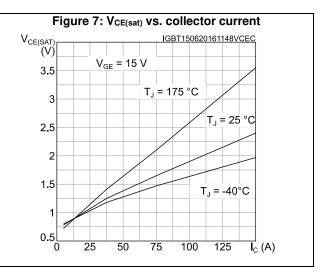






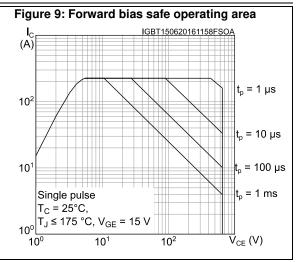


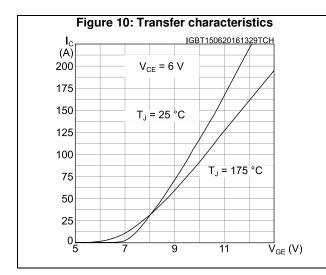


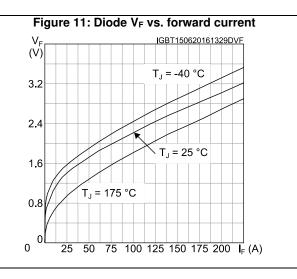


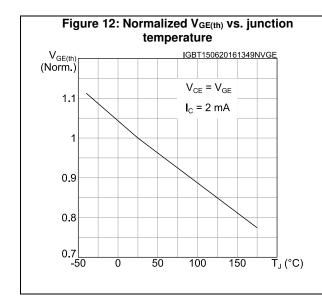
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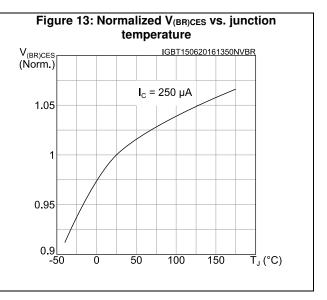
Figure 8: Collector current vs. switching frequency IGBT150620161157CCS Rectangular current shape (duty cycle = 0.5, V_{CC} = 400 V, R_G = 3.3 Ω , V_{GE} = 0/15 V, T_J = 175 °C) 120 100 T_C = 80 °C 80 60 T_C = 100 °C 40 20 ol f (kHz) 10¹ 10² 10⁰

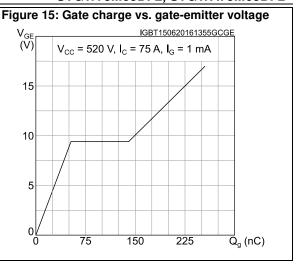


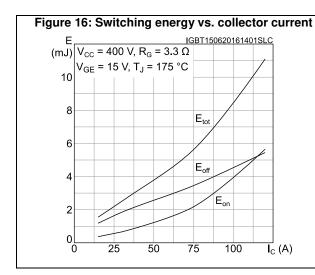


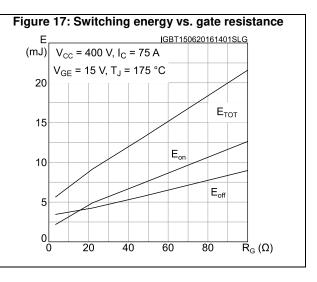


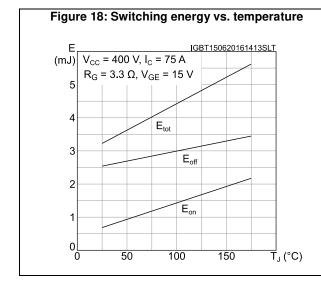












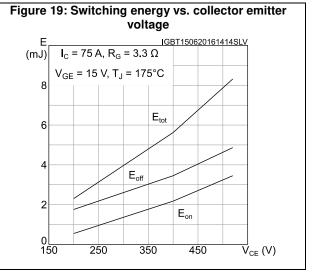
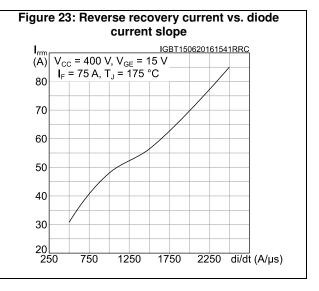
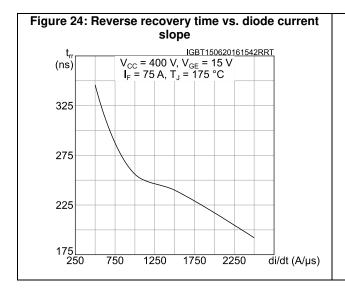
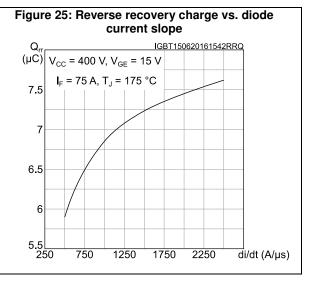


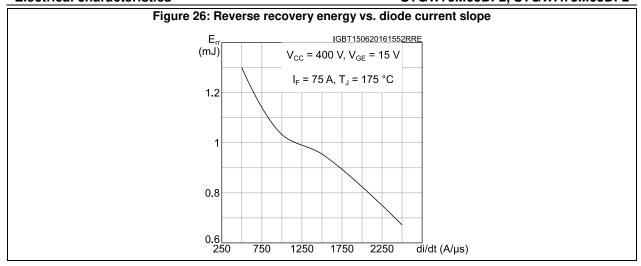
Figure 20: Short-circuit time and current vs. VgE Te anu U.

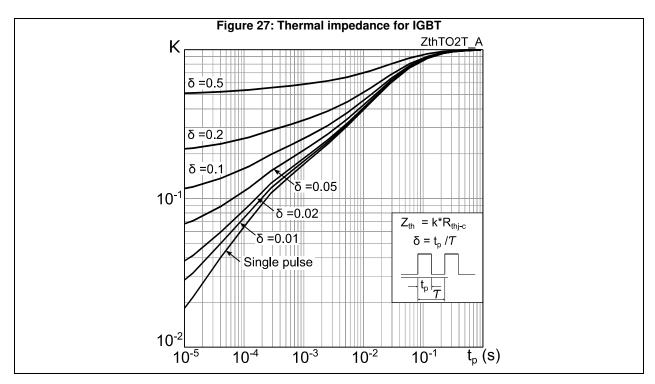
IGBT150620161438SCV | ISC (A) (µs) V_{CC} ≤ 400 V, T_J ≤ 150°C 225 20 t_{SC} I_{SC} 15 175 10 125 5L 9 75 12 13 14 $\overline{V}_{GE}(V)$

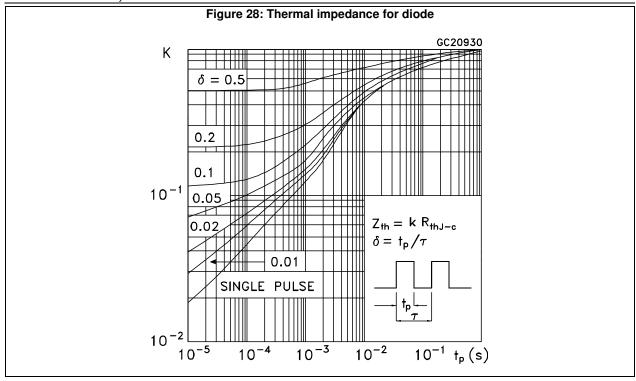






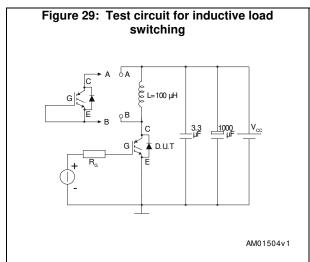


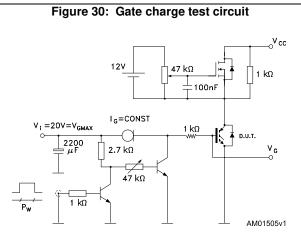


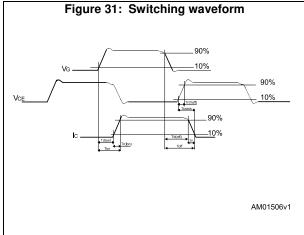


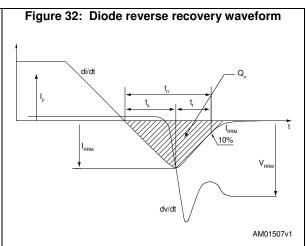
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3 Test circuits









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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-247 package information

HEAT-SINK PLANE øΡ S øR Ľ2 *b1 b2* BACK VIEW 0075325_8

Figure 33: TO-247 package outline

Table 8: TO-247 package mechanical data

Dim	·	mm	
Dim.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

4.2 TO-247 long leads package information

Figure 34: TO-247 long leads package outline

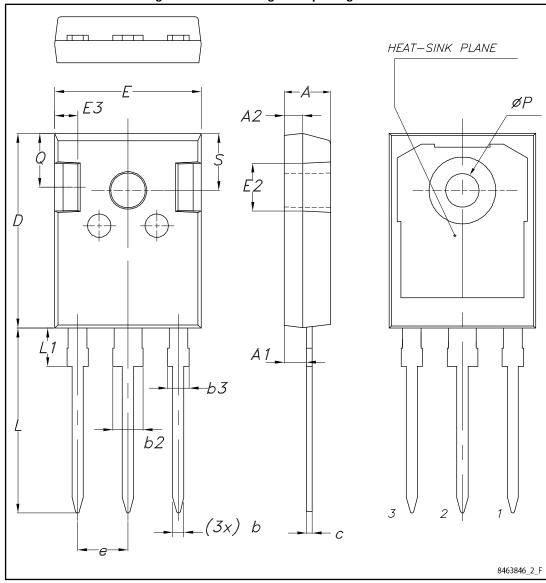


Table 9: TO-247 long leads package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
С	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
е	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
Р	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
02-Dec-2015	1	First release.
15-Jun-2016	2	Inserted device in TO-247 and document updated accordingly. Inserted Section 2.1: "Electrical characteristics (curves)". Document status promoted from preliminary to production data. Minor text changes.
03-May-2017	3	Modified: title, features and application on cover page. Modified Table 4: "Static characteristics", Table 7: "Diode switching characteristics (inductive load)" and Figure 13: "Normalized V _{(BR)CES} vs. junction temperature". Minor text changes.

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